

### SSC8021GS9

#### P-Channel Enhancement Mode MOSFET with ESD Protection

#### > Features

VDS	VGS	RDSON Typ.	ID	ESD	
201/	.42)/	0.65R@-4V5	0.04	01-1/	
-20V	±12V	0.9R@-2V5	-0.8A	2kV	

### > Description

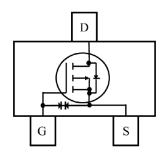
This device is produced with high cell density DMOS trench technology, which is especially used to minimize on-state resistance. This device particularly suits low voltage such applications as portable equipment, power management and other battery powered circuits, and low in-line power dissipation are needed in a very small outline surface mount package. The product does not contain Rohs substances such as lead and halogen.

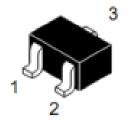
# Applications

- Load Switch
- Portable Devices
- DCDC conversion

### > Pin configuration

Top view





**SOT723** 



Marking

## > Ordering Information

Device	Package	Shipping
SSC8021GS9	SOT723	8000/Reel



# ➤ Absolute Maximum Ratings(T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V <sub>DSS</sub>	Drain-to-Source Voltage	-20	V
V <sub>GSS</sub>	Gate-to-Source Voltage	±12	V
l <sub>D</sub>	Continuous Drain Current <sup>a</sup>	-0.8	Α
I <sub>DM</sub>	Pulsed Drain Current b	-2	Α
P <sub>D</sub>	Power Dissipation <sup>c</sup>	0.33	W
P <sub>DSM</sub>	Power Dissipation <sup>a</sup>	0.19	W
TJ	Operation junction temperature	-55 to 150	℃
Тѕтс	Storage temperature range	-55 to 150	℃

# ➤ Thermal Resistance Ratings( $T_A=25^{\circ}$ C unless otherwise noted)

Symbol	Parameter	Typical	Maximum	Unit
R <sub>0</sub> JA	Junction-to-Ambient Thermal Resistance		657	°C/W
Rejc	Junction-to-Case Thermal Resistance		378	C/VV

#### Note:

- a. The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz.copper,in a still air environment with  $T_A$ =25 $C^{\circ}$ . The value in any given application depends on the user is specific board design. The current rating is based on the t  $\leq$  10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation  $P_D$  is based on  $T_{J(MAX)}$ =150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.

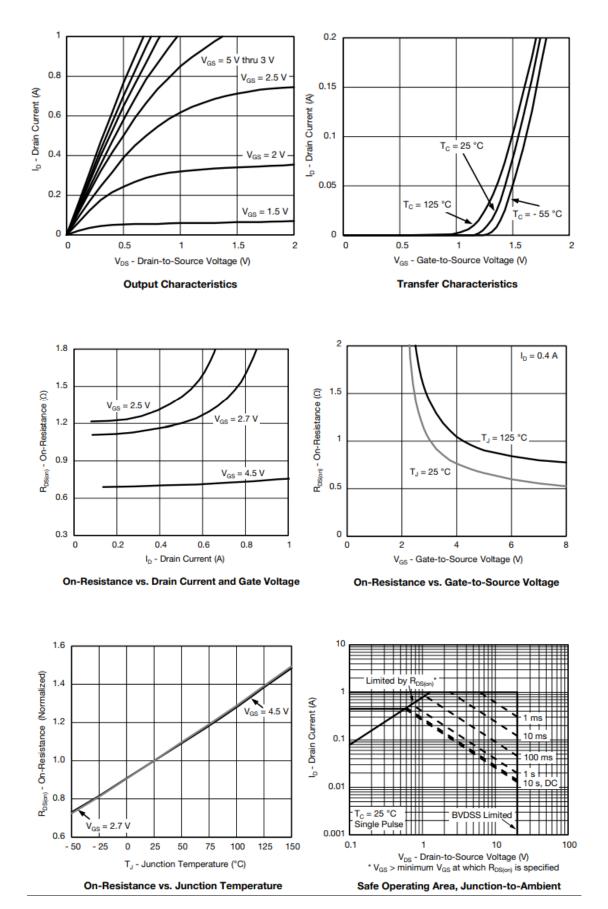


# ➤ Electronics Characteristics(T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	<b>Test Conditions</b>	Min	Тур.	Max	Unit
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	VGS=0V,ID=-250uA	-20			V
V <sub>GS</sub> (th)	Gate Threshold Voltage	VDS=VGS,ID=-250uA	-0.5	-0.7	-1	V
Rps(an)	Drain-Source On-	VGS=-4.5V,ID=-0.5A		650	800	_
R <sub>DS(on)</sub>	Resistance	VGS=-2.5V,ID=-0.5A		900	1100	mR
I <sub>DSS</sub>	Zero Gate Voltage  Drain Current	VDS=-16V,VGS=0V			-1	uA
I <sub>GSS</sub>	Gate-Source leak	VGS=±12V,VDS=0V			±10	uA
G <sub>FS</sub>	Transconductance	VDS=-5V,ID=-0.45A		1.5		S
V <sub>SD</sub>	Forward Voltage	VGS=0V,IS=-0.15A			-1.2	V
Ciss	Input Capacitance			105		
Coss	Output Capacitance	VDS=10V, VGS=0V, F=200KHZ		22		pF
Crss	Reverse Transfer Capacitance			18		
T <sub>D(ON)</sub>	Turn-on delay time			54		
Tr	Rise time	VGS=6V,		85		no
T <sub>D(OFF)</sub>	Turn-off delay time	VGEN=4.5V, RL=6R, RG=6R,ID=0.5A		890		ns
Tf	Fall time			176		



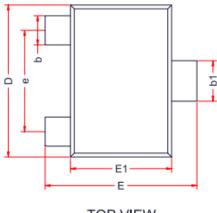
# ➤ Typical Characteristics(T<sub>A</sub>=25°C unless otherwise noted)

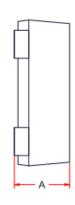




# Package Information

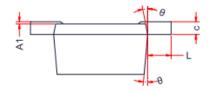
#### SOT-723





TOP VIEW

SIDE VIEW



SIDE VIEW

Sumbal	Din	Dimensions in Millimeters			
Symbol	Min.	Тур.	Max.		
A	0.43	-	0.55		
A1	0.00	-	0.05		
С	0.08	0.13	0.18		
b1	0.27	-	0.37		
b	0.17	-	0.27		
L1	0.15	0.20	0.25		
D	1.15	1.20	1.25		
E	1.15	1.20	1.25		
E1	0.75	0.80	0.85		
е	0.80 Ref.				
θ	7 ° Ref.				



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